

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tsuyoshi KAWAKAMI	09/15/2009
Akihiko FURUKAWA	09/15/2009
Satoshi YAMAKAWA	09/15/2009
Tetsuya IIDA	10/06/2009
Masao KONDO	10/08/2009
Yutaka HOSHINO	10/21/2009
RECEIVING PARTY DATA	
Name:	RENESAS TECHNOLOGY CORP.
Street Address:	6-2, Otemachi 2-chome, Chiyoda-ku,
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12617488
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ATTORNEY DOCKET NUMBER:	067237-0564
NAME OF SUBMITTER:	Bernard P. Codd

CH \$40.00 12617488

Total Attachments: 2

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RECORDATION FORM COVER SHEET

Docket No.: 067237-0564

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)
 Tsuyoshi KAWAKAMI, Akihiko FURUKAWA, Satoshi YAMAKAWA, Tetsuya IIDA, Masao KONDO, Yutaka HOSHINO
 Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
 Name: **RENESAS TECHNOLOGY CORP.**

 Address: **6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, JAPAN**

3. Nature of Conveyance/Execution Date(s)

 Execution Date(s): **September 15, 2009; September 15, 2009; September 15, 2009; October 6, 2009; October 8, 2009 and October 21, 2009 respectively**

Assignment **Merger**
 Security Agreement **Change of Name**
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other

Additional name(s) & address(es) attached? Yes No

4. Application or patent number(s):
 A. Patent Application No(s).

 Additional numbers attached? Yes No

This document is being filed together with a new application.
 B. Patent No(s).

5. Name and address to whom correspondence concerning document should be mailed:

 Name: **MCDERMOTT WILL & EMERY LLP**
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 City: **Washington** State: **D. C.** Zip: **20005-3096**

 Phone Number: **202.756.8000**
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6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information:

 a. Credit Card Last 4 Numbers _____
 Expiration Date _____
 b. Deposit Account Number 500417
 Authorized User Name _____

9. Signature.
Stephen A. Becker 26,527 *Bernard P. Gold (Reg. No. 46, 429)* **November 12, 2009**

Name and Registration No. of Person Signing _____ Signature _____ Date _____

Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT
(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan, located at 6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Tsuyoshi Kawakami</u> Tsuyoshi KAWAKAMI	<u>15/September/2009</u>
2) <u>Akihiko Furukawa</u> Akihiko FURUKAWA	<u>15/September/2009</u>
3) <u>Satoshi Yamakawa</u> Satoshi YAMAKAWA	<u>15/September/2009</u>
4) <u>Tetsuya Iida</u> Tetsuya IIDA	<u>6/October/2009</u>
5) <u>Masao Kondo</u> Masao KONDO	<u>8/October/2009</u>
6) <u>Yutaka Hoshino</u> Yutaka HOSHINO	<u>21/October/2009</u>
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____